



**IRF330-333/IRF730-733**  
**MTM/MTP5N35/5N40**  
**N-Channel Power MOSFETs,**  
**5.5 A, 350 V/400 V**

Power And Discrete Division

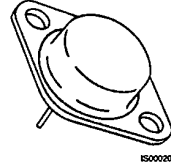
T-39-11

**Description**

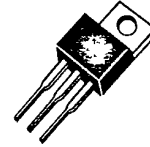
These devices are n-channel, enhancement mode, power MOSFETs designed especially for high voltage, high speed applications, such as off-line switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers.

- $V_{GS}$  Rated at  $\pm 20$  V
- Silicon Gate for Fast Switching Speeds
- $I_{DSS}$ ,  $V_{DS(on)}$ , SOA and  $V_{GS(th)}$  Specified at Elevated Temperature
- Rugged

TO-204AA



TO-220AB



IRF330  
 IRF331  
 IRF332  
 IRF333  
 MTM5N35  
 MTM5N40

IRF730  
 IRF731  
 IRF732  
 IRF733  
 MTP5N35  
 MTP5N40

**Maximum Ratings**

Symbol	Characteristic	Rating IRF330/332 IRF730/732 MTM/MTP5N40	Rating IRF331/333 IRF731/733 MTM/MTP5N35	Unit
$V_{DSS}$	Drain to Source Voltage	400	350	V
$V_{DGR}$	Drain to Gate Voltage $R_{GS} = 1.0 \text{ M}\Omega$	400	350	V
$V_{GS}$	Gate to Source Voltage	$\pm 20$	$\pm 20$	V
$T_J, T_{stg}$	Operating Junction and Storage Temperature	-55 to +150	-55 to +150	$^{\circ}\text{C}$
$T_L$	Maximum Lead Temperature for Soldering Purposes, 1/8" From Case for 5 s	275	275	$^{\circ}\text{C}$

**Maximum On-State Characteristics**

		IRF330/331 IRF730/731	IRF332/333 IRF732/733	MTM5N35/40 MTP5N35/40	
$R_{DS(on)}$	Static Drain-to-Source On Resistance	1.0	1.5	1.0	$\Omega$
$I_D$	Drain Current Continuous Pulsed	5.5 22	4.5 22	5.0 22	A

**Maximum Thermal Characteristics**

		1.67	1.67	1.67	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case				
$P_D$	Total Power Dissipation at $T_C = 25^{\circ}\text{C}$	75	75	75	W

**Notes**  
 For information concerning connection diagram and package outline, refer to Section 7.

## IRF330-333/IRF730-733

T-39-11

Electrical Characteristics ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
--------	----------------	-----	-----	------	-----------------

## Off Characteristics

$V_{(BR)DSS}$	Drain Source Breakdown Voltage <sup>1</sup>			V	$V_{GS} = 0\text{ V}$ , $I_D = 250\ \mu\text{A}$
	IRF330/332/730/732	400			
	IRF331/333/731/733	350			
$I_{DSS}$	Zero Gate Voltage Drain Current		250	$\mu\text{A}$	$V_{DS} = \text{Rated } V_{DSS}$ , $V_{GS} = 0\text{ V}$
			1000	$\mu\text{A}$	$V_{DS} = 0.8 \times \text{Rated } V_{DSS}$ , $V_{GS} = 0\text{ V}$ , $T_C = 125^\circ\text{C}$
$I_{GSS}$	Gate-Body Leakage Current IRF330-333 IRF730-733		$\pm 100$ $\pm 500$	nA	$V_{GS} = \pm 20\text{ V}$ , $V_{DS} = 0\text{ V}$

## On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	2.0	4.0	V	$I_D = 250\ \mu\text{A}$ , $V_{DS} = V_{GS}$
$R_{DS(on)}$	Static Drain-Source On-Resistance <sup>2</sup>			$\Omega$	$V_{GS} = 10\text{ V}$ , $I_D = 3.0\text{ A}$
		IRF330/331/730/731		1.0	
		IRF332/333/732/733		1.5	
$g_{fs}$	Forward Transconductance	3.0		S ( $\Omega$ )	$V_{DS} = 10\text{ V}$ , $I_D = 3.0\text{ A}$

## Dynamic Characteristics

$C_{iss}$	Input Capacitance		900	pF	$V_{DS} = 25\text{ V}$ , $V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$
$C_{oss}$	Output Capacitance		300	pF	
$C_{rss}$	Reverse Transfer Capacitance		80	pF	

Switching Characteristics ( $T_C = 25^\circ\text{C}$ , Figures 12, 13)

$t_{d(on)}$	Turn-On Delay Time		30	ns	$V_{DD} = 175\text{ V}$ , $I_D = 3.0\text{ A}$ $V_{GS} = 10\text{ V}$ , $R_{GEN} = 15\ \Omega$ $R_{GS} = 15\ \Omega$
$t_r$	Rise Time		35	ns	
$t_{d(off)}$	Turn-Off Delay Time		55	ns	
$t_f$	Fall Time		35	ns	
$Q_g$	Total Gate Charge		30	nC	$V_{GS} = 10\text{ V}$ , $I_D = 7.0\text{ A}$ $V_{DD} = 180\text{ V}$

Symbol	Characteristic	Typ	Max	Unit	Test Conditions
--------	----------------	-----	-----	------	-----------------

## Source-Drain Diode Characteristics

$V_{SD}$	Diode Forward Voltage IRF330/331/730/731		1.6	V	$I_S = 5.5\text{ A}$ ; $V_{GS} = 0\text{ V}$
	IRF332/333/732/733		1.5	V	$I_S = 4.5\text{ A}$ ; $V_{GS} = 0\text{ V}$
$t_{rr}$	Reverse Recovery Time	400		ns	$I_S = 5.5\text{ A}$ ; $di_S/dt = 100\text{ A}/\mu\text{S}$

## MTM/MTP5N35/5N40

T-39-11

Electrical Characteristics ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
<b>Off Characteristics</b>					
$V_{(BR)DSS}$	Drain Source Breakdown Voltage <sup>1</sup>			V	$V_{GS} = 0\text{ V}, I_D = 5.0\text{ mA}$
	MTM/MTP5N40	400			
	MTM/MTP5N35	350			
$I_{DSS}$	Zero Gate Voltage Drain Current		0.25	mA	$V_{DS} = 0.85 \times \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}$
			2.5	mA	$V_{DS} = 0.85 \times \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}, T_C = 100^\circ\text{C}$
$I_{GSS}$	Gate-Body Leakage Current		$\pm 500$	nA	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$
<b>On Characteristics</b>					
$V_{GS(th)}$	Gate Threshold Voltage	2.0	4.5	V	$I_D = 1.0\text{ mA}, V_{DS} = V_{GS}$
		1.5	4.0	V	$I_D = 1.0\text{ mA}, V_{DS} = V_{GS}, T_C = 100^\circ\text{C}$
$R_{DS(on)}$	Static Drain-Source On-Resistance <sup>2</sup>		1.0	$\Omega$	$V_{GS} = 10\text{ V}, I_D = 2.5\text{ A}$
$V_{DS(on)}$	Drain-Source On-Voltage <sup>2</sup>		2.5	V	$V_{GS} = 10\text{ V}; I_D = 2.5\text{ A}$
			6.2	V	$V_{GS} = 10\text{ V}, I_D = 5.0\text{ A}$
			5.0	V	$V_{GS} = 10\text{ V}, I_D = 2.5\text{ A}, T_C = 100^\circ\text{C}$
$g_{fs}$	Forward Transconductance	2.0		S ( $\Omega$ )	$V_{DS} = 10\text{ V}, I_D = 2.5\text{ A}$
<b>Dynamic Characteristics</b>					
$C_{iss}$	Input Capacitance		1200	pF	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$
$C_{oss}$	Output Capacitance		300	pF	
$C_{rss}$	Reverse Transfer Capacitance		80	pF	
<b>Switching Characteristics (<math>T_C = 25^\circ\text{C}</math>, Figures 12, 13)<sup>3</sup></b>					
$t_{d(on)}$	Turn-On Delay Time		50	ns	$V_{DD} = 25\text{ V}, I_D = 2.5\text{ A}$ $V_{GS} = 10\text{ V}, R_{GEN} = 50\ \Omega$ $R_{GS} = 50\ \Omega$
$t_r$	Rise Time		100	ns	
$t_{d(off)}$	Turn-Off Delay Time		200	ns	
$t_f$	Fall Time		100	ns	
$Q_g$	Total Gate Charge		30	nC	$V_{GS} = 10\text{ V}, I_D = 7.0\text{ A}$ $V_{DD} = 180\text{ V}$

## Notes

- $T_J = +25^\circ\text{C}$  to  $+150^\circ\text{C}$
- Pulse test: Pulse width  $\leq 80\ \mu\text{s}$ , Duty cycle  $\leq 1\%$
- Switching time measurements performed on LEM TR-58 test equipment.

IRF330-333/IRF730-733  
MTM/MTP5N35/5N40

T-39-11

Typical Performance Curves

Figures 4-6 for IRF332/333/732/733 only.

Figure 1 Output Characteristics

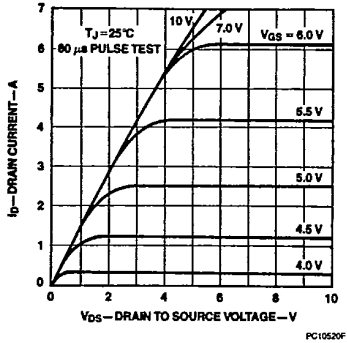


Figure 2 Static Drain to Source Resistance vs Drain Current

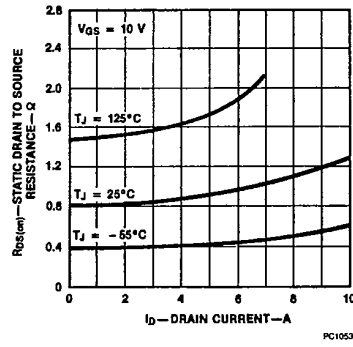


Figure 3 Transfer Characteristics

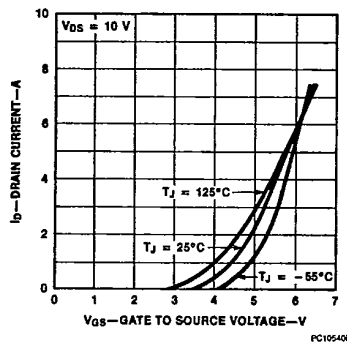


Figure 4 Output Characteristics

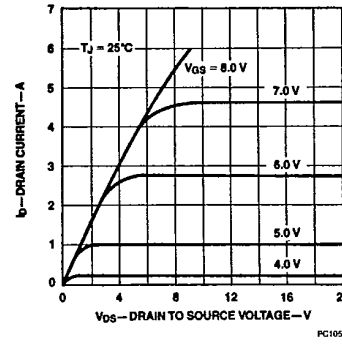


Figure 5 Static Drain to Source On-Resistance vs Drain Current

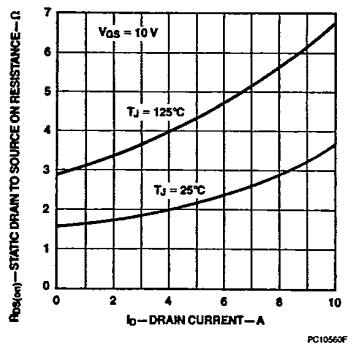
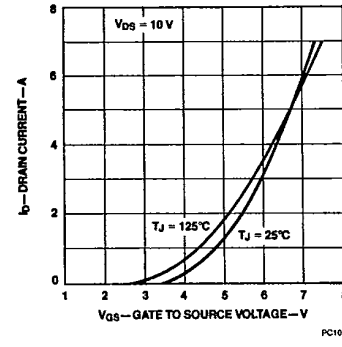


Figure 6 Transfer Characteristics

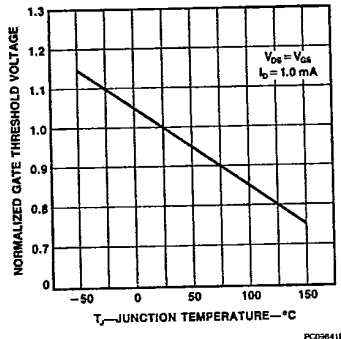


**IRF330-333/IRF730-733**  
**MTM/MTP5N35/5N40**

T-39-11

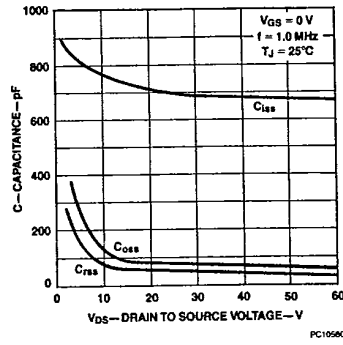
Typical Performance Curves (Cont.)

Figure 7 Temperature Variation of Gate to Source Threshold Voltage



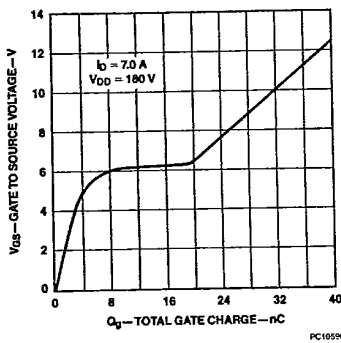
PC09641F

Figure 8 Capacitance vs Drain to Source Voltage



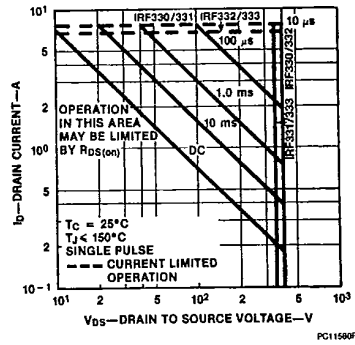
PC10560F

Figure 9 Gate to Source Voltage vs Total Gate Charge



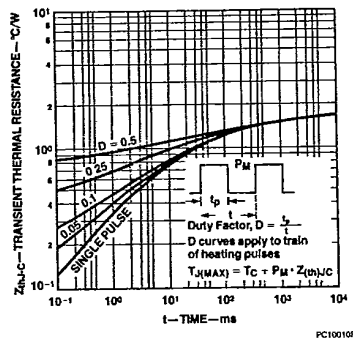
PC10550F

Figure 10 Forward Biased Safe Operating Area



PC11560F

Figure 11 Transient Thermal Resistance



PC10010F

IRF330-333/IRF730-733  
MTM/MTP5N35/5N40

T-39-11

Typical Electrical Characteristics

Figure 12 Switching Test Circuit

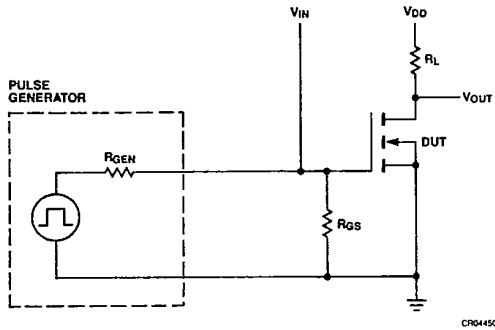
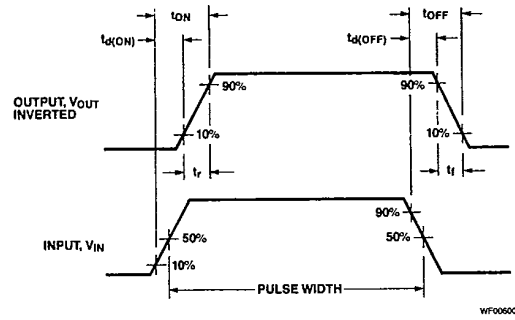


Figure 13 Switching Waveforms



2

This datasheet has been downloaded from:

[www.DatasheetCatalog.com](http://www.DatasheetCatalog.com)

Datasheets for electronic components.



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

[LittleDiode.com](http://LittleDiode.com)

Looking forward to providing you with the best possible service.